

STTH61R04TV

Ultrafast recovery diode

Main product characteristics

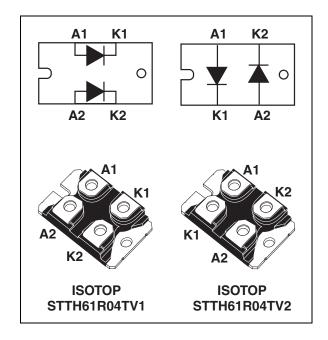
I _{F(AV)}	2 x 30 A
V _{RRM}	400 V
Tj	150° C
V _{F (typ)}	0.95 V
t _{rr (typ)}	24 ns

Features and benefits

- Ultrafast
- Very low switching losses
- High frequency and high pulsed current operation
- Low leakage current
- Insulated package:
 - ISOTOP
 Electrical insulation = 2500 V_{RMS}
 Capacitance = 45 pF

Description

The STTH61R04TV series uses ST's new 400 V planar Pt doping technology. The STTH61R04 is specially suited for switching mode base drive and transistor circuits, such as welding equipment.



Order codes

Part Number	Marking
STTH61R04TV1	STTH61R04TV1
STTH61R04TV2	STTH61R04TV2

Characteristics STTH61R04TV

Characteristics 1

Absolute ratings (limiting values per diode at 25° C, unless otherwise specified) Table 1.

Symbol	Parameter			Value	Unit	
V_{RRM}	Repetitive peak reverse voltage	Repetitive peak reverse voltage			400	V
V _{RSM}	Non repetitive peak reverse voltage				400	V
I _{F(RMS)}	RMS forward current			60	Α	
I _{F(AV)}	Average forward current, $\delta = 0.5$	Per diode		T _c = 80° C	30	Α
I _{FRM}	Repetitive peak forward current	$t_p = 5 \mu s, F = 1 kH$	Iz square		900	Α
I _{FSM}	Surge non repetitive forward current	urrent t _p = 10 ms Sinusoidal		350	Α	
T _{stg}	Storage temperature range			-65 to + 150	°C	
Tj	Maximum operating junction tempera	iture			150	°C

Table 2. Thermal parameters

Symbol	Parameter		Value	Unit
R _{th(j-c)}	Junction to case	Per diode 1.5		
	Total	Total	0.8	° C/W
R _{th(c)}	Coupling thermal resistance		0.1	

When the diodes are used simultaneously:

 $\Delta T_{j(diode1)} = P_{(diode1)} \times R_{th(j-c)}$ (per diode) + $P_{(diode2)} \times R_{th(c)}$

Table 3. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур	Max.	Unit
I _R ⁽¹⁾ Reverse leakage current	T _j = 25° C	V - V			15		
	neverse leakage current	T _j = 125° C	$V_R = V_{RRM}$		15	150	μΑ
		T _j = 25° C				1.45	
V _F ⁽²⁾	Forward voltage drop	T _j = 100° C	I _F = 30 A		1.05	1.3	V
		T _j = 150° C			0.95	1.20	

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2$ %

To evaluate the conduction losses use the following equation: P = 0.9 x $I_{F(AV)}$ + 0.01 x $I_{F}^{2}_{(RMS)}$

$$P = 0.9 \text{ x } I_{E(\Delta V)} + 0.01 \text{ x } I_{E^2(BMS)}$$

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^{2.} Pulse test: t_p = 380 μ s, δ < 2 %

STTH61R04TV Characteristics

Table 4. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур	Max.	Unit
		$I_F = 1 \text{ A, } dI_F/dt = -50 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$			65	
t _{rr}	Reverse recovery time	$I_F = 1 \text{ A, } dI_F/dt = -100 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$		31	45	ns
		$I_F = 1 \text{ A, } dI_F/dt = -200 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$		24	35	
I _{RM}	Reverse recovery current	$I_F = 30 \text{ A}, dI_F/dt = -200 \text{ A/}\mu\text{s}, \ V_R = 320 \text{ V}, T_j = 125^{\circ} \text{ C}$		10	14	Α
S	Softness factor	$I_F = 30 \text{ A}, dI_F/dt = -200 \text{ A/}\mu\text{s}, \ V_R = 320 \text{ V}, T_j = 125^{\circ} \text{ C}$		0.4		
t _{fr}	Forward recovery time	$I_F = 30 \text{ A}$ $dI_F/dt = 100 \text{ A/}\mu\text{s}$ $V_{FR} = 1.5 \text{ x } V_{Fmax}, T_j = 25^{\circ} \text{ C}$		250		ns
V _{FP}	Forward recovery voltage	I_F = 30 A, dI_F/dt = 100 A/ μ s, T_j = 25° C		2.9		V

Figure 1. Conduction losses versus average current

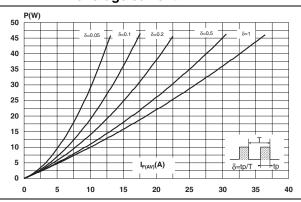


Figure 2. Forward voltage drop versus forward current

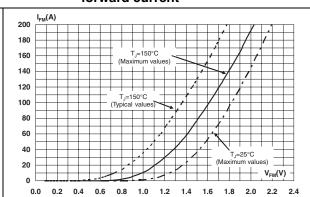
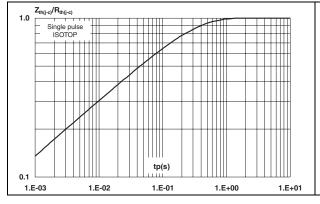
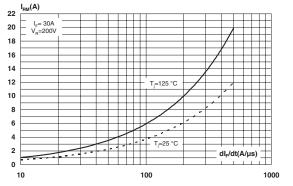


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

Figure 4. Peak reverse recovery current versus dl_F/dt (typical values)

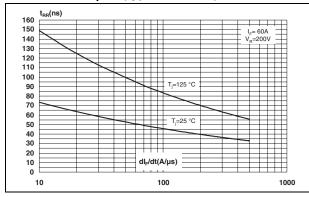




Characteristics STTH61R04TV

Figure 5. Reverse recovery time versus dl_F/dt (typical values)

Figure 6. Reverse recovery charges versus dl_F/dt (typical values)



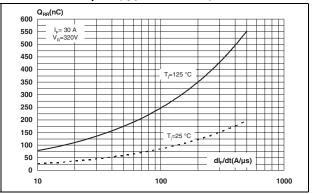
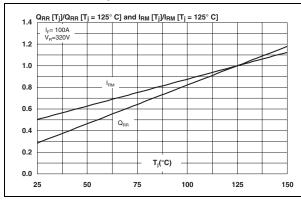


Figure 7. Relative variations of dynamic parameters versus junction temperature

Figure 8. Transient peak forward voltage versus dl_F/dt (typical values)



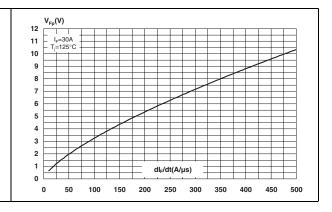
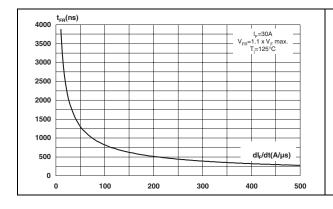
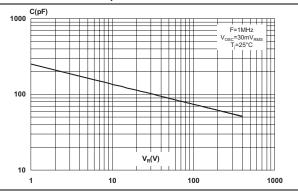


Figure 9. Forward recovery time versus dI_F/dt Figure 10. Junction (typical values)

Junction capacitance versus reverse voltage applied (typical values)





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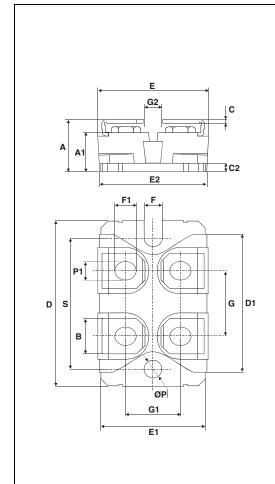
STTH61R04TV Package information

2 Package information

Epoxy meets UL94, V0

Cooling method: by conduction (C)

Table 5. ISOTOP dimensions



		Dimer	nsions	
Ref.	Millim	neters	Inc	hes
	Min.	Max.	Min.	Max.
Α	11.80	12.20	0.465	0.480
A1	8.90	9.10	0.350	0.358
В	7.8	8.20	0.307	0.323
С	0.75	0.85	0.030	0.033
C2	1.95	2.05	0.077	0.081
D	37.80	38.20	1.488	1.504
D1	31.50	31.70	1.240	1.248
Е	25.15	25.50	0.990	1.004
E1	23.85	24.15	0.939	0.951
E2	24.80) typ.	0.976 typ.	
G	14.90	15.10	0.587	0.594
G1	12.60	12.80	0.496	0.504
G2	3.50	4.30	0.138	0.169
F	4.10	4.30	0.161	0.169
F1	4.60	5.00	0.181	0.197
Р	4.00	4.30	0.157	0.69
P1	4.00	4.40	0.157	0.173
S	30.10	30.30	1.185	1.193

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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Ordering information STTH61R04TV

3 Ordering information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
STTH61R04TV1	STTH61R04TV1	ISOTOP	27 g	10	Tube
STTH61R04TV2	STTH61R04TV2	ISOTOP	27 g	10	Tube

4 Revision history

Date	Revision	Description of Changes
31-Mar-2007	1	First issue

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